

IN THE CLAIMS:

1. (Withdrawn) An organic EL panel in which organic EL elements including at least an organic emissive layer are arranged in matrix form between pixel electrodes each having a size corresponding to an emissive region of one pixel and opposing electrodes being opposed to the pixel electrodes, the organic EL panel comprising:

an insulating film in the form of a frame which covers peripheral edges of each of the pixel electrodes, and

a protrusion having a thickness greater than that of said insulating film and provided on the outside of the insulating film.

2. (Withdrawn) An organic EL panel according to claim 1, wherein said protrusion is made of the same material as said insulating film.

3. (Withdrawn) An organic EL panel according to claim 1, wherein said protrusion is configured by arranging a plurality of pillar components so as to discretely surround the periphery of the insulating film.

4. (Withdrawn) An organic EL panel according to claim 1, wherein a recess in the form of a frame from which said insulating film is removed is formed between said insulating film and the protrusion.

5. (Withdrawn) An organic EL panel according to claim 1, wherein said protrusion works as a mask support for bearing a mask for evaporation.

6. (Withdrawn) An organic EL panel according to claim 1, wherein said protrusion works as a support for bearing a donor sheet which releases an organic material by laser irradiation.

7. (Currently Amended) A method of manufacturing an organic EL panel in which organic EL elements are arranged in a matrix, each organic EL comprising~~including~~ at least an organic emissive layer disposed~~are arranged in matrix form between a pixel electrodes electrode~~

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and an opposing electrode, wherein each pixel electrode has each having a size corresponding to an emissive region of one pixel, and wherein the opposing electrode is opposed to each pixel electrode and corresponds to a plurality of pixels, opposing electrodes being opposed to the pixel electrodes, the manufacturing method comprising: the steps of:

forming the pixel electrodes;

forming an insulating films, in the form of a frame, wherein each insulating film has a form of a frame that which covers peripheral edges of each of the pixel electrodes; and

forming protrusions around each insulating film, provided on the outside of the insulating film and wherein each protrusion has having a thickness greater than that of the insulating film around which the protrusions surrounds; on the pixel electrodes; and

forming the organic emissive layer while the protrusions is are supporting a mask.

8. (Currently Amended) A method of manufacturing an organic EL panel according to claim 7, wherein each said insulating film and the each protrusion are formed through a two-step exposure process comprising a first exposure to light for forming the thickness of the said insulating film and a second exposure to light for removing the insulating film.

9. (Currently Amended) A method of manufacturing an organic EL panel according to claim 7, wherein each said insulating film and the each protrusion are formed through a gray-tone exposure processing of a region where the said insulating film is formed such that light exposure varies among the a a portion of the region from which the said insulating film is removed, a portion of the region on which the said insulating film is provided, and a portion of the region on which the said protrusion is provided.

10. (Currently Amended) A method of manufacturing an organic EL panel in which organic EL elements are arranged in a matrix, each organic EL comprising including at least an organic emissive layer are arranged in matrix form disposed between a pixel electrodes electrode and an opposing electrode, wherein each pixel electrode each having has a size corresponding to an emissive region of one pixel, and wherein the opposing electrode is opposed to each pixel

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electrode and corresponds to a plurality of pixels and opposing electrodes being opposed to the pixel electrodes, the manufacturing method comprising: the steps of:

forming the pixel electrodes;

forming an insulating film, wherein each insulating film has a form of a frame that in the form of a frame, which covers peripheral edges of each of the pixel electrodes; and a protrusion, provided on the outside of the insulating film and having

forming protrusions around each insulating film, wherein each protrusion has a thickness greater than that of the said insulating film; and on the pixel electrodes, and

forming the organic emissive layer such that, while the said protrusions are is supporting a donor sheet on which a layer made of an organic emissive material is formed, the organic emissive material is released from the said donor sheet by laser irradiation so as to be deposited on the said pixel electrodes.

11. (Currently Amended) A method of manufacturing an organic EL panel according to claim 10, wherein said each insulating film and each the protrusion are formed through a two-step exposure process comprising a first exposure to light for forming the thickness of the said insulating film and a second exposure to light for removing the insulating film.

12. (Currently Amended) A method of manufacturing an organic EL panel according to claim 10, wherein said each insulating film and the each protrusion are formed through a gray-tone exposure processing of a region where the said insulating film is formed such that light exposure varies among the a portion of the region from which the said insulating film is removed, a portion of the region on which the said insulating film is provided, and a portion of the region on which the said protrusion is provided.

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